

Blockchain Security 2Go

Short Product Overview

Description

The Blockchain Security 2Go is a starter kit for development of secured blockchain applications like crypto currency wallets (e.g. Bitcoin, Ethereum) or eSignature/PKI. It supports the most important security functions on a highly fraud protected chip and provides dedicated APIs for an external communication via contactless interface to e.g. a NFC smartphone. An Android based API incl. example application is available on top of it.

The high security chip provided with the kit can be integrated into most common blockchain ecosystems to safeguard user credentials against various attacks like cloning, forgery etc. This emphasizes the security of the whole system in comparison with only software based solutions.

The starter kit contains

- 5 credit card sized ID1 cards based on ISO/IEC 7810 having a contactless interface and a Class 1 communication antenna based on ISO/IEC 14443.
- On-card software that supports commands for key-management, signature creation and PIN authentication.
- Open-source software that exemplifies how to integrate the features of the Blockchain Security 2Go cards in a real-world Blockchain system (e.g. sending cryptocurrencies or integrating the cards in a smart contract for eVoting). The software is hosted on GitHub <u>https://github.com/Infineon/Blockchain</u>.



Features

Hardware Features

- ID1 contactless card
- Supported interface: ISO/IEC 14443 (NFC)
- Cryptographic support: TRNG, ECC, AES

Software Features

- PIN Authentication
- Generate ECC keypair (secp256k1)
- Get Public Key
- Generate signature
- Encrypted keyload
- Storage of up to 255 keypairs
- Preloaded ECC curve (secp256k1) for e.g. Bitcoin, Ethereum

Applications

- Compatible to Android 6+
- Crypto currency wallet example
- eVoting example based on Ethereum



Example of open source android APP interaction with public APIs such as blockchain.info





Applications

Product name	Blockchain Security 2Go
Product description	Blockchain starter kit
Interfaces	ISO/IEC 14443
Memory	500kByte SOLID FLASH™ NVM
	12kByte RAM
CPU	16-bit
Symmetrical cryptography	AES 256bit
Asymmetrical cryptography	ECC 256bit
Ambient temperature	-25 to + 85 °C (Chip)
	-25 to + 70 °C (ID1 card body)
Delivery forms	ID1 card(s)
Typical applications	Most common Blockchain applications like Bitcoin wallet,
	Ethereum smart contract, eSignature, Asset Management

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Infineon Technologies AG

81726 München, Germany

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Email: erratum@infineon.com

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